

Analog absolute pressure sensor, 20 kPa to 250 kPa Rev. 5 — 29 July 2022 Product

Product data sheet

1 General description

The FXPS7250A4 high-performance, high-precision absolute pressure sensor consists of a compact capacitive micro-electro-mechanical systems (MEMS) device coupled with a digital integrated circuit (IC) producing a fully calibrated analog output.

This sensor is ideal for many automotive applications such as manifold air pressure (MAP), comfort seating, and other applications requiring operating absolute pressure ranges up to 250 kPa.

The sensing element is based on NXP's high precision capacitive pressure cell technology. The architecture benefits from redundant pressure transducers as an expanded quality measure. It delivers highly accurate ratiometric analog readings of absolute pressure while operating from either a 3.3 V or 5.0 V power supply.

The sensor operates over a pressure range of 20 kPa to 250 kPa and over a wide temperature range of -40 °C to 130 °C.

The sensor comes in an industry-leading 4 mm x 4 mm x 1.98 mm, restriction of hazardous substances (RoHS) compliant, high-power quad flat no-lead (HQFN)

package^[1] suitable for small printed circuit board (PCB) integration. Its AEC-Q100^[2] compliance, high accuracy, reliable performance, and high media resistivity make it ideal for use in automotive, industrial, and consumer applications.

2 Features and benefits

- Absolute pressure range: 20 kPa to 250 kPa
- Operating temperature range: -40 °C to 130 °C
- Analog output for monitoring of the absolute pressure signal
- Pressure transducer and digital signal processor (DSP)
 Internal self-test
- Capacitance to voltage converter with anti-aliasing filter
- Sigma delta ADC plus sinc filter
- 800 Hz or 1000 Hz low-pass filter for absolute pressure
- Lead-free, 16-pin HQFN, 4 mm x 4 mm x 1.98 mm package

3 Applications

3.1 Automotive

- Manifold air pressure
 - MAP
- Small engine control
- Liquid propane gas (LPG) or compressed natural gas (CNG) engine management



Analog absolute pressure sensor, 20 kPa to 250 kPa

3.2 Industrial

- Compressed air
- Manufacturing line control
- · Gas metering
- Weather stations

3.3 Medical/Consumer

- Blood pressure monitor
- Medicine dispensing systems
- White goods

4 Ordering information

Table 1. Ordering information

Type number	Package				
	Name	Description	Version		
FXPS7250A4	HQFN16	HQFN16, plastic, thermal enhanced quad flat pack; no leads; 16 terminals; 0.8 mm pitch; 4 mm x 4 mm x 1.98 mm body	SOT1573-1		

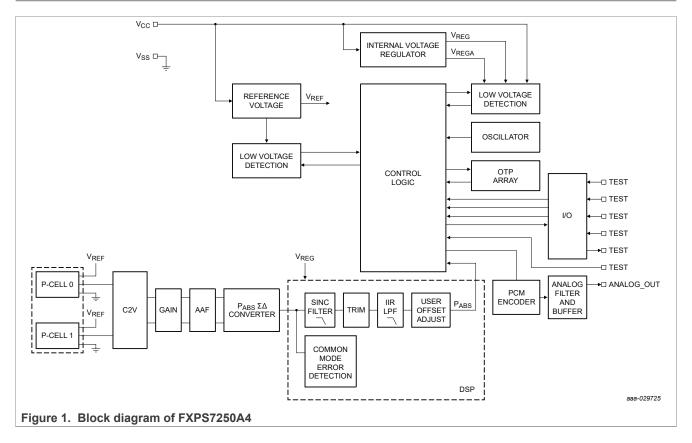
4.1 Ordering options

Table 2. Ordering options

Device	Range (kPa)	Packing	Temperature range
FXPS7250A4T1	20 kPa to 250 kPa	Packing Tape and Reel	-40 °C to 130 °C

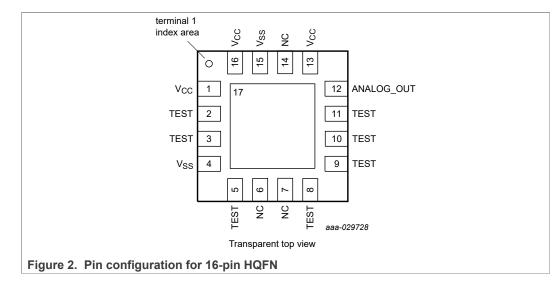
Analog absolute pressure sensor, 20 kPa to 250 kPa

5 Block diagram



6 Pinning information





Analog absolute pressure sensor, 20 kPa to 250 kPa

6.2 Pin description

Table 3. Pin description

Pin	Pin name	Description
2, 8, 9, 10	TEST	Pins 2, 8, 9, and 10 are test pins and must be left unterminated in the application.
3	TEST	Pin 3 is required to be tied to V_{CC} for device operation.
4, 15	V _{SS}	Pins 4 and 15 are the supply return nodes and are connected internally to the die attach pad (pin 17).
5, 11	TEST	Pins 5 and 11 are test pins and must be tied to V_{SS}
6, 7, 14	NC	Pins 6, 7 and 14 are not internally connected and can be left unconnected in the application.
12	ANALOG_OUT	Pin 12 provides a ratiometric analog output proportional to the absolute pressure sensor data.
1, 13, 16	V _{CC}	Pins 1, 13 and 16 supply power to the device. An external capacitor must be connected between these pins and V_{SS} , as shown in the application diagram.
17	PAD	Pin 17 is the die attach flag and must be connected to V _{SS} .

7 Functional description

7.1 Voltage regulators

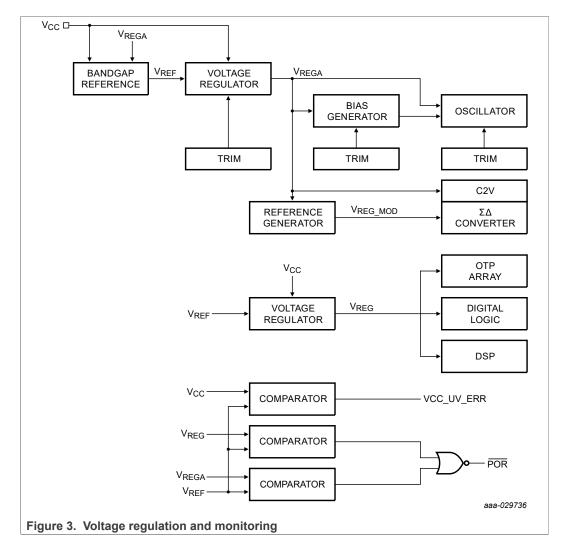
The device derives its internal supply voltage from the V_{CC} and V_{SS} pins. An external filter capacitor is required for V_{CC}, as shown in <u>Figure 12</u>.

A reference generator provides a reference voltage for the $\Sigma\Delta$ converter.

NXP Semiconductors

FXPS7250A4

Analog absolute pressure sensor, 20 kPa to 250 kPa



7.2 Pressure sensor signal path

7.2.1 $\Sigma\Delta$ converter

A second order sigma delta modulator converts the voltage from the analog front end to a data stream that is input to the DSP. A simplified block diagram is shown in Figure 4.

Analog absolute pressure sensor, 20 kPa to 250 kPa

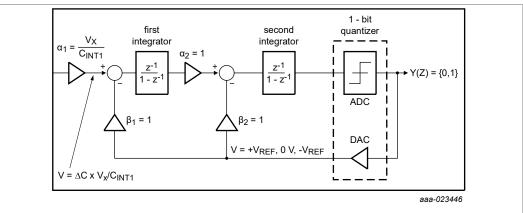


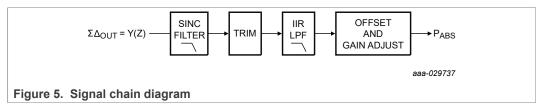
Figure 4. $\Sigma\Delta$ converter block diagram

The sigma delta modulator operates at a frequency of 1 MHz, with the transfer function in Equation 1.

$$H(Z) = \frac{\alpha_1}{Z^2} \tag{1}$$

7.2.2 Digital signal processor (DSP)

A DSP is used to perform signal filtering and compensation. A diagram illustrating the signal processing flow within the DSP is shown in <u>Figure 5</u>.

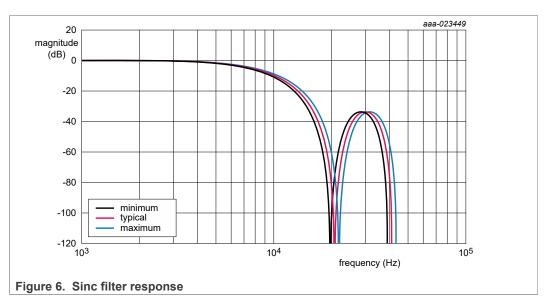


7.2.2.1 Decimation sinc filter

In Equation 2, the output of the $\Sigma\Delta$ modulator is decimated and converted to a parallel value by two third-order sinc filters; the first with a decimation ratio of 24 and the second with a decimation ratio of 4.

$$H(Z) = \left(\frac{1}{24^3}\right) \times \left(\frac{1 - Z^{-24}}{1 - Z^{-1}}\right)^3 \quad H(Z) = \left(\frac{1}{4^3}\right) \times \left(\frac{1 - Z^{-4}}{1 - Z^{-1}}\right)^3 \tag{2}$$

Analog absolute pressure sensor, 20 kPa to 250 kPa



7.2.2.2 Signal trim and compensation

The device includes digital trim to compensate for sensor offset, sensitivity, and nonlinearity over temperature.

7.2.2.3 Low-pass filter

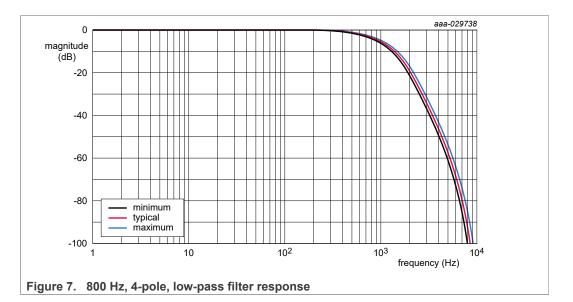
Data from the sinc filter is processed by an infinite impulse response (IIR) low-pass filter with the transfer function and coefficients shown in <u>Equation 3</u>.

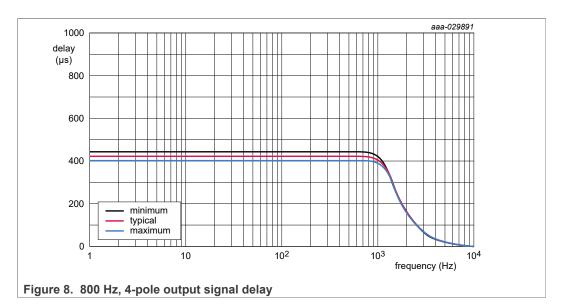
$$H(Z) = a_0 \times \frac{(n_{11} \times z^0) + (n_{12} \times z^{-1}) + (n_{13} \times z^{-2})}{(d_{11} \times z^0) + (d_{12} \times z^{-1}) + (d_{13} \times z^{-2})} \times \frac{(n_{21} \times z^0) + (n_{22} \times z^{-1}) + (n_{23} \times z^{-2})}{(d_{21} \times z^0) + (d_{22} \times z^{-1}) + (d_{23} \times z^{-2})}$$
(3)

Filter number	Typical –3 dB frequency	Filter order	Filter coefficients (24 bit)				Group delay (µs)	Typical attenuation @ 1000 Hz (dB)
1	800 Hz	4	a ₀	0.088642612609670	-	-	418	4.95
			n ₁₁	0.029638050039039	d ₁₁	1	-	
			n ₁₂	0.087543281056143	d ₁₂	-1.422792640957290		
			n ₁₃	0.029695285913601	d ₁₃	0.511435253566960	-	
			n ₂₁	0.250241278804809	d ₂₁	1		
			n ₂₂	0.499999767379068	d ₂₂	-1.503329908017845		
			n ₂₃	0.249758953816089	d ₂₃	0.621996524706640		
2	1000 Hz	4	a ₀	0.129604264748411	-	-	333	2.99
			n ₁₁	0.043719804402508	d ₁₁	1		
			n ₁₂	0.087543281056143	d ₁₂	-1.300502656562698		
			n ₁₃	0.043823599710731	d ₁₃	0.430106921311110		
			n ₂₁	0.250296586927511	d ₂₁	1		
			n ₂₂	0.499999648540934	d ₂₂	-1.379959571988366		
			n ₂₃	0.249703764531484	d ₂₃	0.555046257157745		

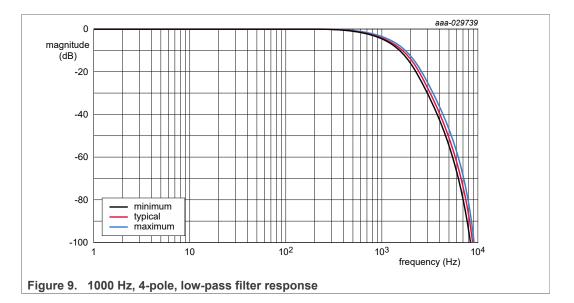
Table 4. IIR low pass filter coefficients

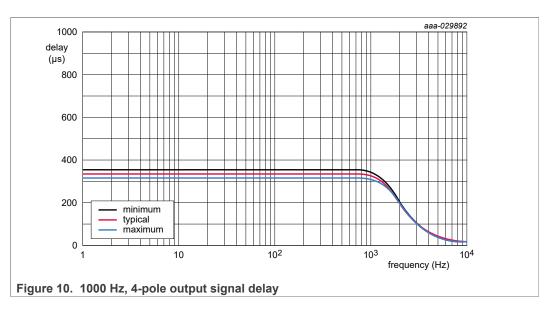
Analog absolute pressure sensor, 20 kPa to 250 kPa





Analog absolute pressure sensor, 20 kPa to 250 kPa





7.3 Analog output function

7.3.1 Analog output signal chain

The device provides an analog output ratiometric to the supply voltage. The analog output is enabled by default. Selecting the analog output enables the following functions:

- The non-interpolated P_{ABS} sensor data output is saturated to 10 bits and converted to an unsigned value.
- The 10-bit sensor value is input into a summer clocked at 10 MHz.
- The carry from the summer circuit generates a PCM output.
- The PCM signal is filtered by a 2-pole active low pass filter to generate an analog signal.

Analog absolute pressure sensor, 20 kPa to 250 kPa

7.3.2 Analog output transfer function

The FXPS7250A4 device provides an analog output voltage ratiometric to the supply voltage.

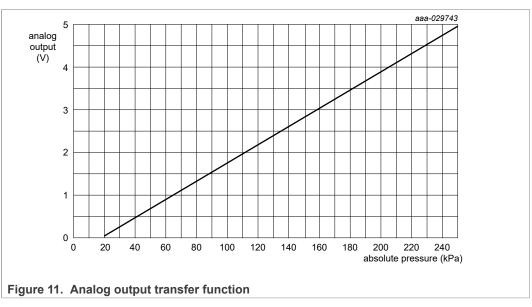
If using a supply voltage other than 5 V, the general form of the transfer function should be applied as described in equation $\underline{Equation 4}$:

$$Pressure_k Pa = 10 + 250 \times \left(A_{OUT}/V_{CC}\right)$$
⁽⁴⁾

In addition, the absolute pressure analog offset, $\mathsf{P}_{\mathsf{OFF}}$ and output voltage span, $\mathsf{V}_{\mathsf{FSS}}$, then becomes a ratio of their magnitude by applying the ratio of (V_{CC} / 5 V) to each of these parameters.

There can be slight variations in the P_{OFF} and V_{FSS} based on the temperature. The minimum and maximum variation of P_{OFF} and V_{FSS} can be assessed by applying the same ratio (V_{CC} / 5 V) to both of these parameters and then applying the error percentages to obtain these variations if needed.

The analog output transfer function for a 5.0 V supply is as shown in Figure 11.



8 Maximum ratings

Absolute maximum ratings are the limits that the device can be exposed to without permanently damaging it. Absolute maximum ratings are stress ratings only; functional operation at these ratings is not guaranteed. Exposure to absolute maximum ratings conditions for extended periods might affect device reliability.

This device contains circuitry to protect against damage due to high static voltage or electrical fields. NXP advises that normal precautions be taken to avoid application of any voltages higher than maximum-rated voltages to this high-impedance circuit.

FXPS7250A4 Product data sheet

© 2022 NXP B.V. All rights reserved

Analog absolute pressure sensor, 20 kPa to 250 kPa

Table 5. Maximum ratings

Symbol	Parameter	Conditions		Min	Max	Unit
VCC _{MAX}	Supply Voltage	V _{CC} , V _{CCIO}	[1]	—	+6.0	V
VIOMAX	Input/Output Max on pins	ANALOG_OUT TESTx	[1]	-0.3	V _{CC} + 0.3	V
h _{DROP}	Drop shock	To concrete, tile or steel surface, 10 drops, any orientation	[2]	_	1.2	m
T _{stg}	Temperature range	Storage	[2]	-40	+130	°C
TJ	_	Junction	[3]	-40	+150	°C
P _{MAX}	Maximum absolute pressure	Continuous	[3]	—	300	kPa
P _{BURST}	_	Burst (tested at 100 ms)	[2]	—	750	kPa
P _{MIN}	Minimum absolute pressure	Continuous	[1]	—	20	kPa
f _{SEAL}	Pressure sealing force	Applied to top face of package	[1]	—	10	N
θ _{JA}	Thermal resistance		[4]	—	120	°C/W
ESD and latch-up protect	tion characteristics					
V _{ESD}	Electrostatic discharge (per	Human body model (HBM)	[2]	-2000	2000	V
V _{ESD}	AEC-Q100, Rev H)	Charge device model (CDM)	[2] [5]	-500	500	V

[1]

Parameter verified by parametric and functional validation. Parameter verified by qualification testing (Per AEC-Q100 Rev H or per NXP specification). [2]

[3] [4] Functionality verified by modeling, simulation and/or design verification.

Thermal resistance provided with device mounted to a two-layer, 1.6 mm FR-4 PCB as documented in AN1902^[1] with one signal layer and one ground layer.

CDM tested at ±750 V for corner pins and ±500 V for all other pins. [5]



Caution

This device is sensitive to mechanical shock. Improper handling can cause permanent damage to the part.



Caution This is an ESD sensitive device. Improper handling can cause permanent damage to the part.

Operating range 9

Table 6. Electrical characteristics - supply and I/O

 $V_{CC_min} \le (V_{CC} - V_{SS}) \le V_{CC_max}, T_L \le T_A \le T_H, \Delta T \le 25 \text{ °C/min}, unless otherwise specified.$

Symbol	Parameter	Conditions	Min	Max	Units
V _{CC}	Supply voltage	Measured at V _{CC} ^[1]	3.10	5.25	V
T _A	Operating temperature range	V _{CC} = 5.0 V, unless otherwise stated. Production tested operating temperature ^[1] range	T _L -40	Т _Н +130	°C
T _A		Guaranteed operating temperature range [1]	-40	+130	°C
V _{CC_RAMP}	Supply power on ramp rate	[2] [3]	0.00001	10	V/µs

[1] Parameter tested at final test.

FXPS7250A4

Analog absolute pressure sensor, 20 kPa to 250 kPa

Functionality verified by modeling, simulation and/or design verification. [2]

[3] Parameter verified by parametric and functional validation.

10 Static characteristics

Table 7. Static characteristics

 $V_{CC_min} \leq (V_{CC} - V_{SS}) \leq V_{CC_max}, T_L \leq T_A \leq T_H, \Delta T \leq 25 \text{ °C/min, unless otherwise specified.}$

Symbol	Parameter	Condition		Min	Тур	Max	Units
Supply and I/O	·						
Iq	Supply current	V _{CC} = 5.0 V	[1]	_	_	8.0	mA
Temperature sense	or signal chain				ł	·	·
V _{OH_ANA}	Output high voltage	ANALOG_OUT, I _{Load} = –100 μΑ	[1]	V _{cc} - 0.2	—	—	V
V _{OL_ANA}	Output low voltage	ANALOG_OUT, I _{Load} = 100 μA	[1]		-	0.2	V
V _{OUT_3dB}	Analog output low-pass filter frequency typical value	–3 dB, 2-pole	[2]	8	-	20	kHz
V _{OUT_3dBTol}	Analog output low-pass filter frequency typical tolerance	–3 dB, 2-pole	[2]	-5	-	5	%
Absolute pressure	e sensor signal chain	•					
P _{ABS}	Absolute pressure range		[1] [3]	20	_	250	kPa
P _{SENS}	Absolute pressure output sensitivity	V _{CC} = 5.0 V. Tested at PA = 140 kPa ± 10 % and 200 kPa ± 10 %	[2]	_	20	_	mV/ kPa
P _{ACC_HIT}	Absolute pressure accuracy	V _{CC} = 5.0 V. 85 °C < T _A ≤ 130 °C	[4]	-3	—	3	%FSS
P _{ACC_Typ}	Absolute pressure accuracy	V _{CC} = 5.0 V. 0 °C ≤ T _A ≤ 85 °C	[4]	-2	-	+2	%FSS
P _{ACC_LoT}	Absolute pressure accuracy	V _{CC} = 5.0 V. -40 °C ≤ T _A < 0 °C	[4]	-3	-	+3	%FSS
P _{OFF}	Absolute pressure analog offset	At pressure span extremes $V_{CC} = 5.0 \text{ V}.$	[4]	—	0.2	-	V
V _{FSS}	Output voltage span	At pressure span extremes V _{CC} = 5.0 V.	[5]	-	4.6	-	V

[1] Parameter verified by pass/fail testing at final test.

[2] Functionality verified by modeling, simulation and/or design verification.

[3] [4] Parameter verified by characterization.

Parameter tested at final test.

[5] Parameter verified by functional evaluation.

Dynamic characteristics 11

Table 8. Dynamic characteristics

 $V_{CC_min} \le (V_{CC} - V_{SS}) \le V_{CC_max}, T_L \le T_A \le T_H, \Delta T \le 25 \text{ °C/min, unless otherwise specified.}$

_	-					
Symbol	Parameter	Condition	Min	Тур	Max	Units
Signal chain		-				
t _{SigChain}	P _{ABS} low-pass filter	Signal chain sample time [1	—	48	_	μs
f _{c0}		Cutoff frequency, filter [1] [2 option #0, 4-pole	_	800	_	Hz
f _{c1}		Cutoff frequency, filter [1] [2 option #1, 4-pole	_	1000	_	Hz
t _{SigDelay}	Signal delay (sinc filter to output delay, excluding the P _{ABS} LPF)	[1	—	—	128	μs

FXPS7250A4

Analog absolute pressure sensor, 20 kPa to 250 kPa

Table 8. Dynamic characteristics...continued

 $V_{CC_min} \leq (V_{CC} - V_{SS}) \leq V_{CC_max}, T_L \leq T_A \leq T_H, \Delta T \leq 25 \text{ °C/min, unless otherwise specified.}$

Symbol	Parameter	Condition	Min	Тур	Max	Units
t _{Delay_DataValid}	Supply recovery	V _{CC} to sensor data valid	300	_	_	ms
f _{Package}	Package resonance frequency	[1]	27.1	_	_	kHz

[1] Functionality verified by modeling, simulation and/or design verification.

[2] Parameter verified by functional evaluation.

12 Media compatibility—pressure sensors only

For more information regarding media compatibility information, contact your local sales representative.

13 Application information

Note: A gel is used to provide media protection against corrosive elements which may otherwise damage metal bond wires and/or IC surfaces. Highly pressurized gas molecules may permeate through the gel and then occupy boundaries between material surfaces within the sensor package. When decompression occurs, the gas molecules may collect, form bubbles and possibly result in delamination of the gel from the material it protects. If a bubble is located on the pressure transducer surface or on the bond wires, the sensor measurement may shift from its calibrated transfer function. In some cases, these temporary shifts could be outside the tolerances listed in the data sheet. In rare cases, the bubble may bend the bond wires and result in a permanent shift.

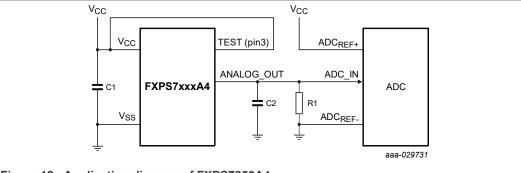


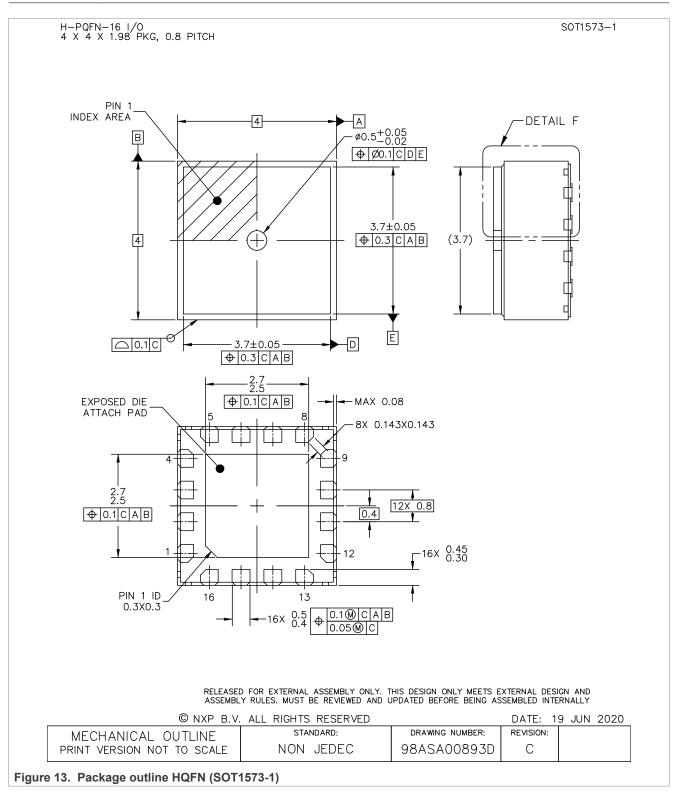
Figure 12. Application diagram of FXPS7250A4

 Table 9. External component recommendations

Name	Туре	Description	Purpose
C1	Ceramic	0.1 µF, 10 %, 10 V minimum, X7R	V _{CC} power supply decoupling
C2	Ceramic	47 pF, 10 %, 10 V minimum, X7R	Analog output filtering
R1	General purpose	51 kΩ, 5 %, 200 PPM	Analog output pull-down resistor

Analog absolute pressure sensor, 20 kPa to 250 kPa

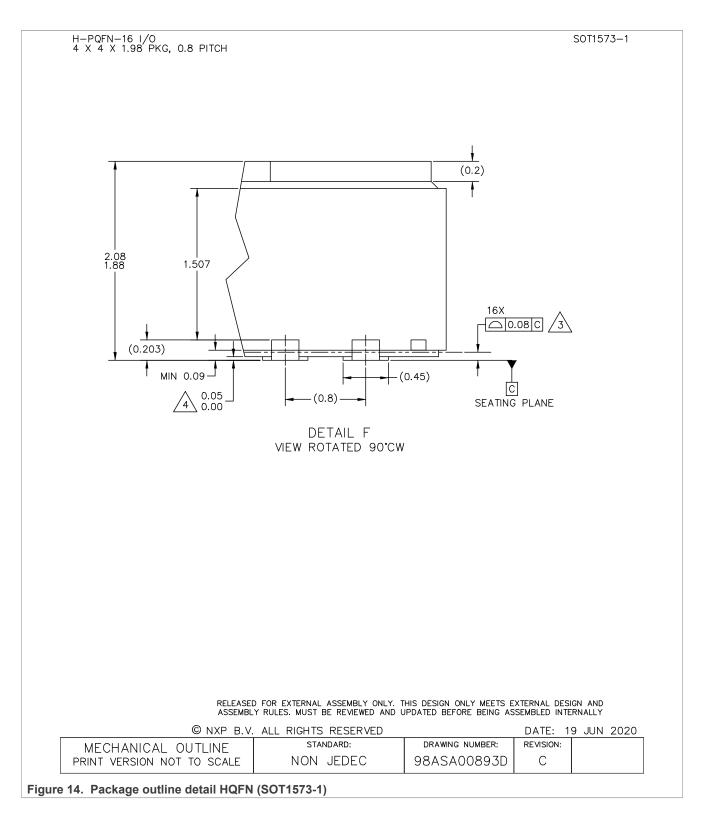
14 Package outline



NXP Semiconductors

FXPS7250A4

Analog absolute pressure sensor, 20 kPa to 250 kPa



NXP Semiconductors

FXPS7250A4

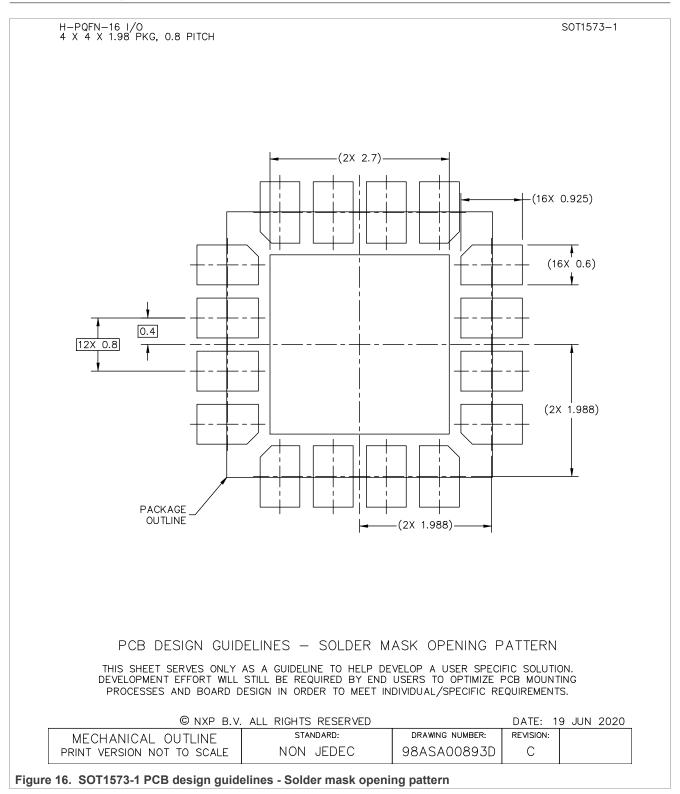
Analog absolute pressure sensor, 20 kPa to 250 kPa

H-PQFN-16 I/O 4 x 4 x 1.98 PKG, 0.8 PITCH	SOT1573-1
NOTES:	
1. ALL DIMENSIONS ARE IN MILLIMETERS.	
2. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994.	
COPLANARITY APPLIES TO LEADS AND DIE ATTACH PAD.	
A DIMENSION APPLIES ONLY FOR TERMINALS.	
5. MIN METAL GAP SHOULD BE 0.2 MM.	
© NXP B.V. ALL RIGHTS RESERVED MECHANICAL OUTLINE STANDARD: DRAWING NU	DATE: 19 JUN 2020 UMBER: REVISION:
PRINT VERSION NOT TO SCALE NON JEDEC 98ASA00	

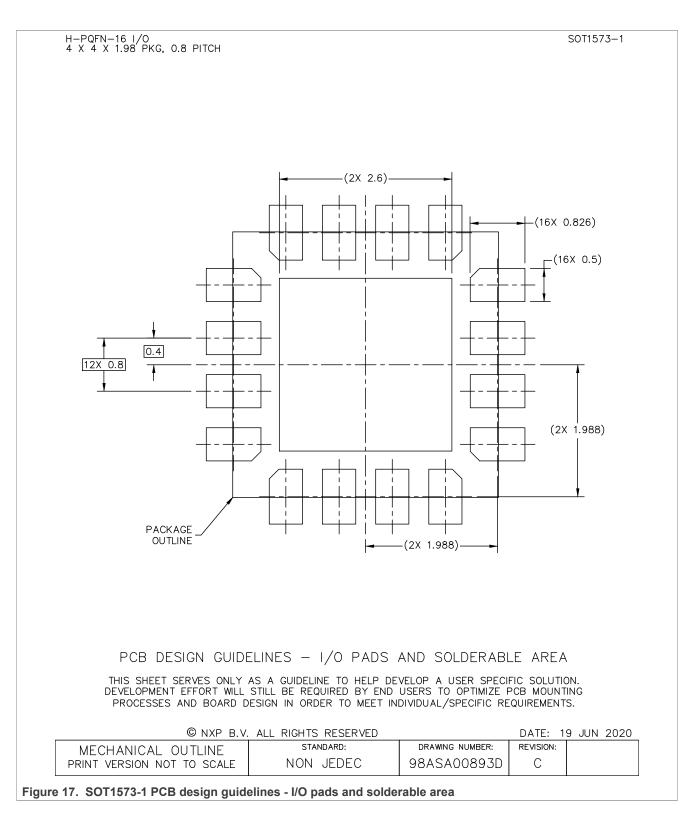
Figure 15. Package outline note HQFN (SOT1573-1)

Analog absolute pressure sensor, 20 kPa to 250 kPa

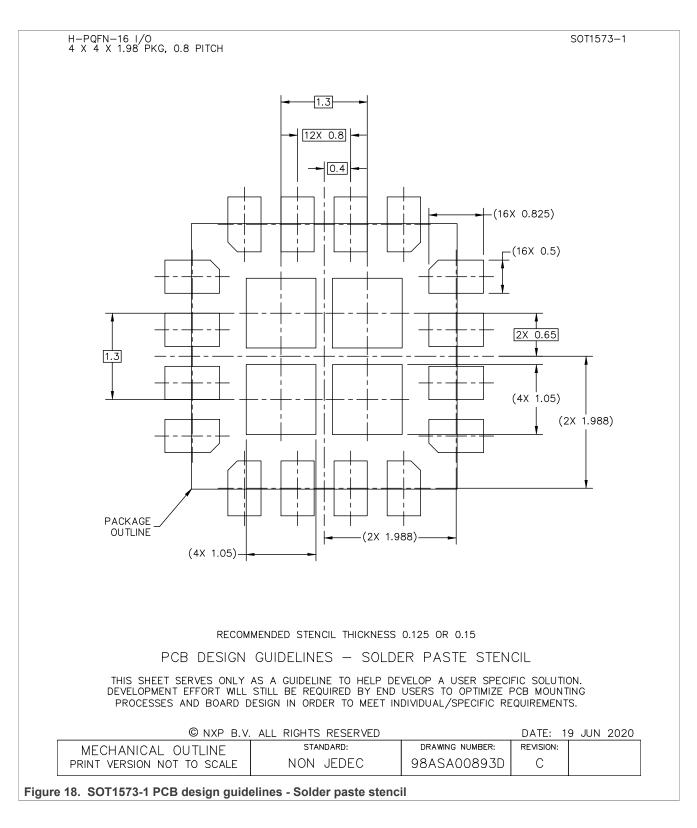
15 Soldering



Analog absolute pressure sensor, 20 kPa to 250 kPa



Analog absolute pressure sensor, 20 kPa to 250 kPa



Analog absolute pressure sensor, 20 kPa to 250 kPa

16 Mounting recommendations

The package should be mounted with the pressure port pointing away from sources of debris which might otherwise plug the sensor.

A plugged port exhibits no change in pressure and can be cross checked in the user software.

Refer to NXP application note AN1902^[1] for proper printed circuit board attributes and recommendations.

17 References

- [1] **AN1902** Assembly guidelines for QFN (quad flat no-lead) and SON (small outline no-lead) packages https://www.nxp.com/docs/en/application-note/AN1902.pdf
- [2] AEC documents on Automotive Electronics Council Component Technical Committee's site: http://www.aecouncil.com/AECDocuments.html

18 Revision history

Table 10. Revision history

Document ID	Release date	Data sheet status	Change notice	Supercedes		
FXPS7250A4 v.5	20220729	Product data sheet	—	FXPS7250A4 v.4.1		
Modifications:	 Performed minor gra Updated the image of Section 6.2, Table 3, m Section 7.2.1, Figure 4 Section 7.2.2, Figure 5 Section 7.3.2, added not Section 9, Table 6, revitested at final test." Section 10, Table 7, Iq: and revised table note test." Section 11, Table 8, ins Section 15 "Soldering", Section 16 "Mounting r 	hed the following global changes: inor grammatical and typographic changes throughout. image on the first page. ble 3, moved pins 5 and 11 from the first row into a separate table row. Figure 4, revised the image. Figure 5, revised the image. added new content to the section, including Equation 4, and revised Figure 11. e 6, revised the table note "Parameter tested 100 % at final test." to "Parameter test." ble 7, Iq: revised the parameter from "Quiescent supply current" to "Supply current". ble 8, inserted new row "t _{Delay_DataValid} " in the table. Idering", inserted new section. munting recommendations", inserted new section. dated the reference section content.				
FXPS7250A4 v.4.1	20190529	Product data sheet	—	FXPS7250A4 v.4		
FXPS7250A4 v.4	20190507	Product data sheet	-	FXPS7250A4 v.3		
FXPS7250A4 v.3	20190506	Preliminary data sheet	—	FXPS7250A4 v.2		
FXPS7250A4 v.2	20190408	Preliminary data sheet	—	FXPS7250A4 v.1		
FXPS7250A4 v.1	20180913	Preliminary data sheet	—	—		

Analog absolute pressure sensor, 20 kPa to 250 kPa

19 Legal information

19.1 Data sheet status

Document status ^{[1][2]}	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <u>http://www.nxp.com</u>.

19.2 Definitions

Draft — A draft status on a document indicates that the content is still under internal review and subject to formal approval, which may result in modifications or additions. NXP Semiconductors does not give any representations or warranties as to the accuracy or completeness of information included in a draft version of a document and shall have no liability for the consequences of use of such information.

Short data sheet — A short data sheet is an extract from a full data sheet with the same product type number(s) and title. A short data sheet is intended for quick reference only and should not be relied upon to contain detailed and full information. For detailed and full information see the relevant full data sheet, which is available on request via the local NXP Semiconductors sales office. In case of any inconsistency or conflict with the short data sheet, the full data sheet shall prevail.

Product specification — The information and data provided in a Product data sheet shall define the specification of the product as agreed between NXP Semiconductors and its customer, unless NXP Semiconductors and customer have explicitly agreed otherwise in writing. In no event however, shall an agreement be valid in which the NXP Semiconductors product is deemed to offer functions and qualities beyond those described in the Product data sheet.

19.3 Disclaimers

Limited warranty and liability — Information in this document is believed to be accurate and reliable. However, NXP Semiconductors does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information. NXP Semiconductors takes no responsibility for the content in this document if provided by an information source outside of NXP Semiconductors.

In no event shall NXP Semiconductors be liable for any indirect, incidental, punitive, special or consequential damages (including - without limitation - lost profits, lost savings, business interruption, costs related to the removal or replacement of any products or rework charges) whether or not such damages are based on tort (including negligence), warranty, breach of contract or any other legal theory.

Notwithstanding any damages that customer might incur for any reason whatsoever, NXP Semiconductors' aggregate and cumulative liability towards customer for the products described herein shall be limited in accordance with the Terms and conditions of commercial sale of NXP Semiconductors.

Right to make changes — NXP Semiconductors reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.

Applications — Applications that are described herein for any of these products are for illustrative purposes only. NXP Semiconductors makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

Customers are responsible for the design and operation of their applications and products using NXP Semiconductors products, and NXP Semiconductors accepts no liability for any assistance with applications or customer product design. It is customer's sole responsibility to determine whether the NXP Semiconductors product is suitable and fit for the customer's applications and products planned, as well as for the planned application and use of customer's third party customer(s). Customers should provide appropriate design and operating safeguards to minimize the risks associated with their applications and products.

NXP Semiconductors does not accept any liability related to any default, damage, costs or problem which is based on any weakness or default in the customer's applications or products, or the application or use by customer's third party customer(s). Customer is responsible for doing all necessary testing for the customer's applications and products using NXP Semiconductors products in order to avoid a default of the applications and the products or of the application or use by customer's third party customer(s). NXP does not accept any liability in this respect.

Limiting values — Stress above one or more limiting values (as defined in the Absolute Maximum Ratings System of IEC 60134) will cause permanent damage to the device. Limiting values are stress ratings only and (proper) operation of the device at these or any other conditions above those given in the Recommended operating conditions section (if present) or the Characteristics sections of this document is not warranted. Constant or repeated exposure to limiting values will permanently and irreversibly affect the quality and reliability of the device.

Terms and conditions of commercial sale — NXP Semiconductors products are sold subject to the general terms and conditions of commercial sale, as published at http://www.nxp.com/profile/terms, unless otherwise agreed in a valid written individual agreement. In case an individual agreement is concluded only the terms and conditions of the respective agreement shall apply. NXP Semiconductors hereby expressly objects to applying the customer's general terms and conditions with regard to the purchase of NXP Semiconductors products by customer.

No offer to sell or license — Nothing in this document may be interpreted or construed as an offer to sell products that is open for acceptance or the grant, conveyance or implication of any license under any copyrights, patents or other industrial or intellectual property rights.

Analog absolute pressure sensor, 20 kPa to 250 kPa

Suitability for use in automotive applications - This NXP product has been qualified for use in automotive applications. If this product is used by customer in the development of, or for incorporation into, products or services (a) used in safety critical applications or (b) in which failure could lead to death, personal injury, or severe physical or environmental damage (such products and services hereinafter referred to as "Critical Applications"), then customer makes the ultimate design decisions regarding its products and is solely responsible for compliance with all legal, regulatory, safety, and security related requirements concerning its products, regardless of any information or support that may be provided by NXP. As such, customer assumes all risk related to use of any products in Critical Applications and NXP and its suppliers shall not be liable for any such use by customer. Accordingly, customer will indemnify and hold NXP harmless from any claims, liabilities, damages and associated costs and expenses (including attorneys' fees) that NXP may incur related to customer's incorporation of any product in a Critical Application.

Export control — This document as well as the item(s) described herein may be subject to export control regulations. Export might require a prior authorization from competent authorities.

Translations — A non-English (translated) version of a document, including the legal information in that document, is for reference only. The English version shall prevail in case of any discrepancy between the translated and English versions.

19.4 Trademarks

Notice: All referenced brands, product names, service names, and trademarks are the property of their respective owners. **NXP** — wordmark and logo are trademarks of NXP B.V.

FXPS7250A4

Analog absolute pressure sensor, 20 kPa to 250 kPa

Tables

Tab. 1.	Ordering information	2
	Ordering options	
Tab. 3.	Pin description	4
	IIR low pass filter coefficients	
	Maximum ratings	

Tab. 6.	Electrical characteristics — supply and I/O 11
Tab. 7.	Static characteristics 12
Tab. 8.	Dynamic characteristics 12
Tab. 9.	External component recommendations
Tab. 10.	Revision history20

Figures

Fig. 1.	Block diagram of FXPS7250A43	
Fig. 2.	Pin configuration for 16-pin HQFN	
Fig. 3.	Voltage regulation and monitoring5	
Fig. 4.	$\Sigma\Delta$ converter block diagram6	
Fig. 5.	Signal chain diagram 6	
Fig. 6.	Sinc filter response7	
Fig. 7.	800 Hz, 4-pole, low-pass filter response	
Fig. 8.	800 Hz, 4-pole output signal delay8	
Fig. 9.	1000 Hz, 4-pole, low-pass filter response 9	
Fig. 10.	1000 Hz, 4-pole output signal delay9	
Fig. 11.	Analog output transfer function	

Fig. 12.	Application diagram of FXPS7250A413
Fig. 13.	Package outline HQFN (SOT1573-1)14
Fig. 14.	Package outline detail HQFN (SOT1573-1) 15
Fig. 15.	Package outline note HQFN (SOT1573-1) 16
Fig. 16.	SOT1573-1 PCB design guidelines - Solder
	mask opening pattern17
Fig. 17.	SOT1573-1 PCB design guidelines - I/O
	pads and solderable area18
Fig. 18.	SOT1573-1 PCB design guidelines - Solder
	paste stencil19

Analog absolute pressure sensor, 20 kPa to 250 kPa

Contents

1	General description	1
2	Features and benefits	1
3	Applications	1
3.1	Automotive	
3.2	Industrial	
3.3	Medical/Consumer	
4	Ordering information	2
4.1	Ordering options	
5	Block diagram	
6	Pinning information	3
6.1	Pinning	3
6.2	Pin description	
7	Functional description	4
7.1	Voltage regulators	4
7.2	Pressure sensor signal path	5
7.2.1	ΣΔ converter	
7.2.2	Digital signal processor (DSP)	6
7.2.2.1	Decimation sinc filter	6
7.2.2.2	Signal trim and compensation	7
7.2.2.3	Low-pass filter	
7.3	Analog output function	
7.3.1	Analog output signal chain	
7.3.2	Analog output transfer function	
8	Maximum ratings	10
9	Operating range	11
10	Static characteristics	
11	Dynamic characteristics	12
12	Media compatibility—pressure sensors	
	only	13
13	Application information	13
14	Package outline	
15	Soldering	
16	Mounting recommendations	
17	References	
18	Revision history	
19	Legal information	21

Please be aware that important notices concerning this document and the product(s) described herein, have been included in section 'Legal information'.

© 2022 NXP B.V.

All rights reserved.

For more information, please visit: http://www.nxp.com

Date of release: 29 July 2022 Document identifier: FXPS7250A4